AVAILABLE

## 28V Linear Li+ Battery Chargers with Battery **Detection and Overvoltage Protected Output**

## **General Description**

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W are intelligent, stand-alone constant-current, constant-voltage (CCCV), thermally regulated linear chargers designed for charging a single-cell lithium-ion (Li+) battery. The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W integrate a current-sense circuit, MOSFET pass element, thermal-regulation circuitry, and eliminate the external reverse-blocking Schottky diode to create the simplest and smallest charging solutions for handheld equipment.

The ICs control the charging sequence from the pregualification state through constant current fast-charge, top-off charge, and full-charge indication. Proprietary thermal-regulation circuitry limits the die temperature during fast-charging or when the ICs are exposed to high ambient temperatures, allowing maximum charging current without damaging the ICs.

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W achieve high flexibility by providing adjustable fastcharge currents (SETI) and an adjustable top-off current threshold (MIN) through external resistors. The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W feature a booting assistant circuit that distinguishes input sources and battery connection and provides an enable signal (ABO-MAX8845Z and ABO-MAX8845Y/MAX8845X/MAX8845W) for system booting.

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W also integrate an overvoltage-protected output (SAFEOUT) for low voltage-rated USB or charger inputs in system, and a battery-pack detection circuit (DETBAT) that disables the charger when the battery pack is absent. Other features include an active-low control input (EN), an active-low input power source detection output (POK), and a fully charged top-off threshold detection output (CHG).

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W accept an input supply range from 4.25V (4.4V for MAX8845W only) to 28V, but disable charging if the supply voltage exceeds +7.5V (+8.0V for MAX8845X only) to protect against unqualified or faulty AC adapters. The ICs operate over the extended temperature range (-40°C to +85°C) and are available in a compact 12-pin, thermally enhanced thin QFN, 3mm x 3mm package (0.8mm max height).

## **Applications**

Cellular and Cordless Phones Smart Phones and PDAs **Digital Still Cameras** MP3 Players **USB** Appliances Charging Cradles and Docks Bluetooth<sup>®</sup> Equipment

## **Features**

- CCCV, Thermally Regulated Linear 1-Cell Li+ **Battery Charger**
- No External MOSFET, Reverse Blocking Diode, or **Current-Sense Resistor**
- Programmable Fast-Charge Currents (1A<sub>RMS</sub> max)
- Programmable Top-Off Current Threshold (MIN)
- Input Overvoltage Protected 4.7V Output (MAX8845Z/MAX8845Y/MAX8845W) or 4.85V (MAX8845X) (SAFEOUT)
- Proprietary Die Temperature Regulation Control (+115°C)
- ♦ 4.25V (4.4V for MAX8845W only) to 28V Input Voltage Range with Input Overvoltage Protection Above +7.5V (+8.0V for MAX8845X only)
- Low-Dropout Voltage (300mV at 500mA)
- ◆ Input Power-Source Detection Output (POK), Charge Status Output (CHG), Charge-Enable Input (EN)
- Output for Autobooting (ABO—MAX8845Z, ABO—MAX8845Y/MAX8845X/MAX8845W)
- Tiny, 3mm x 3mm 12-Pin Thin QFN Package, 0.8mm Height (max)

## **Ordering Information**

PART	PIN-PACKAGE	TOP MARK	ABO ACTIVE STATE
MAX8845ZETC+	12 Thin QFN-EP*	ABL	Active high
MAX8845YETC+	12 Thin QFN-EP*	ABM	Active low
MAX8845XETC+	12 Thin QFN-EP*	ABQ	Active low
MAX8845WETC+	12 Thin QFN-EP*	ABR	Active low

Note: All devices are specified over the -40°C to +85°C operating temperature range.

+Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

Typical Operating Circuit and Pin Configurations appear at end of data sheet.

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Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

## **ABSOLUTE MAXIMUM RATINGS**

IN to GND0.3V to +30\ ABI, BATT, EN, POK, ABO, ABO, CHG, DETBAT, SETI, MIN,	J
SAFEOUT to GND0.3V to +6\	V
IN to BATT Continuous Current1ARMS	S
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
12-Thin QFN (derate 14.7mW/°C above +70°C)	
(multilayer PCB)1176.5mW	V

BATT Short-Circuit Duration	Continuous
Operating Temperature Range	40°C to +85°C
Junction Temperature	
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = 5V, V_{BATT} = 4V, R_{POK} = 1M\Omega$  to BATT,  $\overline{EN} =$  unconnected,  $R_{SETI} = 2.8k\Omega$  to GND,  $V_{DETBAT} = 0$ ,  $C_{BATT} = 2.2\mu$ F,  $T_A = -40^{\circ}$ C to +85°C, unless otherwise noted. Typical values are at  $T_A = +25^{\circ}$ C.) (Note 1)

PARAMETER	CON	DITION	IS	MIN	ТҮР	МАХ	UNITS
Input Supply Voltage Range				0		28	V
			4.25		7.00	V	
Input Supply Operating Voltage Range	MAX8845W only			4.40		7.00	v
	V <sub>IN</sub> rising, 100mV hy	steresi	s (typ)	7.0	7.5	8.0	V
Overvoltage Lockout Trip Threshold	MAX8845X only			$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	8.0	8.5	V
	Constant current cha I <sub>IN</sub> - I <sub>BATT</sub> , I <sub>BATT</sub> = 0				0.22	0.50	
Input Current	Constant current cha I <sub>IN</sub> - I <sub>BATT</sub> , I <sub>BATT</sub> = 5				1		٣A
Input Current	IC disabled, $V_{\overline{EN}} = 5$	V			0.20	0.50	mA
	$V_{IN} = 4V,$		$T_A = +25^{\circ}C$		0.02		
	V <sub>BATT</sub> = 4.2V (4.35V fc MAX8845W only)		T <sub>A</sub> = +85°C		0.03		
BATT, CHG, POK							-
Minimum BATT Bypass Capacitance				2.2		μF	
VBATT Prequalification Threshold Voltage	VBATT rising, 100mV	hyster	esis (typ)	2.3	2.5	2.7	V
	$I_{BATT} = 0   T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		- 10°C to 185°C	4.175	4.200	4.225	<
Battery Regulation Voltage			40 C (0 +05 C	4.158	4.200	4.242	
Dattery negulation voltage	MAX8815W only			4.324	4.350	4.376	v
	WAX0043W Uniy	T rising, 100mV hysteresis (typ) $T = 0$ $T_A = -40^{\circ}C \text{ to } +85^{\circ}C = -40^{\circ}C$	4.306	4.350	4.394		
Regulator Dropout Voltage (VIN - VBATT)	$V_{BATT} = 4.1V, I_{BATT}$	= 425r	mA		260		mV
BATT Input Current	V <sub>IN</sub> = 0 to 4V, V <sub>BATT</sub> = 4.2V (4.35V	for MA	X8845W only)		5	10	μA
	IC disabled				3		
Current-Sense Amplifier Gain (IBATT to ISETI)	I <sub>BATT</sub> = 500mA			1016		μΑ/Α	
	$V_{BATT} = 3.5V,$	T <sub>A</sub> =	0°C to +85°C	460	500	540	
Fast-Charge Current	$R_{SETI} = 2.8 k\Omega$	T <sub>A</sub> =	-40°C to +85°C	425	500	575	mA
			0°C to +85°C	85	100	115	IIIA
CHG Top-Off Threshold	$I_{BATT}$ falling, battery $R_{MIN} = 1.75 k\Omega$	is cha	rged		106		mA

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = 5V, V_{BATT} = 4V, R_{\overline{POK}} = 1M\Omega$  to BATT,  $\overline{EN}$  = unconnected,  $R_{SETI} = 2.8k\Omega$  to GND,  $V_{DETBAT} = 0$ ,  $C_{BATT} = 2.2\mu$ F,  $T_A = -40^{\circ}$ C to +85°C, unless otherwise noted. Typical values are at  $T_A = +25^{\circ}$ C.) (Note 1)

PARAMETER	CONDI	TIONS	MIN	ТҮР	MAX	UNITS
CHG Hysteresis	$I_{BATT}$ rising after top-off is detected, $R_{MIN}$ = 1.75 $\!$			38		mA
CHG Detection Delay	IBATT falls below top-of	f threshold	4.0	6.2	10.7	ms
Prequalification Charge Current	Percentage of the fast- charge current, V <sub>BATT</sub> = 2.2V	$T_A = 0^{\circ}C$ to +85°C	5	10	15	%
CHG, POK Output Low Threshold	$I_{\overline{POK}} = 5 \text{mA}$ , $I_{\overline{CHG}} = 5 \text{m}$	mA			0.4	V
CHG, POK Output High Leakage Current	V <u>POK</u> = 5.5V, V <u>CHG</u> = 5.5V	$T_{A} = +25^{\circ}C$ $T_{A} = +85^{\circ}C$		0.01	1	μA
POK Threshold	VIN - VBATT	V <sub>IN</sub> rising V <sub>IN</sub> falling		40 30		mV
DETBAT, SAFEOUT			•			
DETBAT Logic-Input Low Threshold					0.4	V
DETBAT Logic-Input High Threshold			1.3			v
DETBAT Pullup Resistor	DETBAT to $V_L = 3V$			470		kΩ
Minimum SAFEOUT Bypass Capacitance				1		μF
	ISAFEOUT = 30mA, VIN +85°C (MAX8845Z/MA	4.5	4.7	4.9	- v	
SAFEOUT Regulated Output	ISAFEOUT = 20mA, V <sub>IN</sub> +85°C (MAX8845X)	4.75	4.85	5.0	v	
SAFEOUT Current Limit				100		mA
EN, ABI, ABO, ABO						
EN, ABI Internal Pulldown Resistor			100	200	400	kΩ
EN Logic-Input Low Threshold	4.25V (4.4V for MAX884	45W only) $\leq V_{IN} \leq 7V$			0.4	V
EN Logic-Input High Threshold	4.25V (4.4V for MAX884	4.25V (4.4V for MAX8845W only) $\leq$ V <sub>IN</sub> $\leq$ 7V				V
ABI Logic-Input Low Threshold	$V_{BATT} = 4V, V_{IN} = 0$				0.4	V
ABI Logic-Input High Threshold	$V_{BATT} = 4V, V_{IN} = 0$	$V_{BATT} = 4V, V_{IN} = 0$				V
ABO Output Low Threshold (MAX8845Y/ MAX8845X/MAX8845W)	Open drain, $I_{\overline{ABO}(SINK)} = 1mA$				0.4	V
ABO Output High Threshold (MAX8845Y/ MAX8845X/MAX8845W)	Open drain, 100k $\Omega$ pullup to BATT		V <sub>BATT</sub> - 0.4V			V
ABO Output Low Threshold (MAX8845Z)	I <sub>ABO(SINK)</sub> = 1mA				0.4	V
ABO Output High Threshold (MAX8845Z)	I <sub>ABO(SOURCE)</sub> = 1mA		V <sub>BATT</sub> - 0.4V			V
THERMAL	I		I			1
Die Temperature Regulation Threshold				115		°C
•			1			

Note 1: Specifications are 100% production tested at  $T_A = +25^{\circ}$ C. Limits over the operating temperature range are guaranteed by design and characterization.

4.7k $\Omega$  to GND, C<sub>BATT</sub> = 2.2 $\mu$ F, T<sub>A</sub> = +25°C, unless otherwise noted.) SUPPLY CURRENT **DISABLED MODE SUPPLY CURRENT CHARGE CURRENT** vs. INPUT VOLTAGE vs. INPUT VOLTAGE vs. BATTERY VOLTAGE 1000 1.0 0.6  $V_{\overline{EN}} = 0,$  $V_{\overline{FN}} = 5V$ 900 0.9  $I_{BATT} = 0$ 0.5 VIN RISING 800 0.8 SUPPLY CURRENT (mA) SUPPLY CURRENT (µA) CHARGE CURRENT (mA) 700 0.7 0.4 600 0.6 500 0.5 0.3 400 0.4 0.2 0.3 300 200 0.2 0.1 0.1 100 0 0 0 4 5 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 0 8 12 16 20 24 28 0 10 15 20 25 30 0 INPUT VOLTAGE (V) INPUT VOLTAGE (V) BATTERY VOLTAGE (V) SAFEOUT OUTPUT VOLTAGE **CHARGE CURRENT CHARGE CURRENT** vs. INPUT VOLTAGE vs. INPUT VOLTAGE HEADROOM vs. INPUT VOLTAGE 1000 600 5.0  $V_{BATT} = 4V,$  $V_{IN}$  RISING ISAFEOUT = 1mA 900 4.5 500 800 4.0 CHARGE CURRENT (mA) CHARGE CURRENT (mA) 700 SAFEOUT VOLTAGE (V) 3.5 400 600 3.0 500 2.5 300 400 2.0 200 300 1.5 200 10 100 0.5 100 0 0 0 0 4 8 12 16 20 24 28 0 100 200 300 400 500 600 0 4 8 12 16 20 24 28 INPUT VOLTAGE (V) INPUT VOLTAGE (V) VIN - VBATT (mV) SAFEOUT OUTPUT VOLTAGE SHUTDOWN vs. LOAD CURRENT **STARTUP INTO PRECHARGE** (FAST-CHARGE TO SHUTDOWN) 5.0 4.5 500mA/div 100mA/div <sup>I</sup>BATT 4.0 0 IBATT 0 3.5 SAFEOUT VOLTAGE (V) 5V/div 5V/div VIN 3.0 VIN 2.5 n 5V/div 5V/div VEN VEN 2.0 0 1.5 5V/div 5V/div 1.0 VPOK V<del>pok</del> 0 0 0.5 0 0 20 40 60 80 100 40µs/div 40µs/div LOAD CURRENT (mA)

MIXIM

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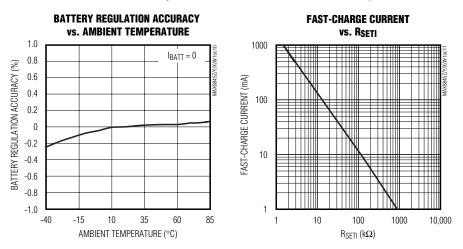
## **Typical Operating Characteristics**

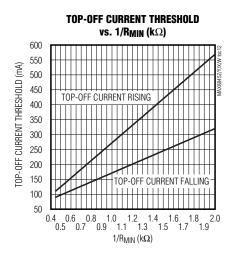
 $(V_{IN} = 5V, V_{BATT} = 4V, R_{POK} = R_{CHG} = 200 k\Omega$  to 5V, EN = unconnected,  $R_{SETI} = 2.8 k\Omega$  to GND,  $R_{MIN} = 1.74 k\Omega$  to GND,  $R_{DETBAT} = 1.74 k\Omega$ 

MAX8845Z/MAX8845Y/MAX8845X/MAX8845W

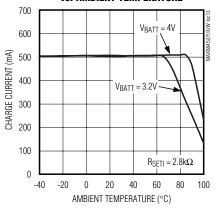


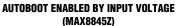
 $(V_{IN} = 5V, V_{BATT} = 4V, R_{POK} = R_{CHG} = 200k\Omega$  to 5V, EN = unconnected,  $R_{SETI} = 2.8k\Omega$  to GND,  $R_{MIN} = 1.74k\Omega$  to GND,  $R_{DETBAT} = 4.7k\Omega$  to GND,  $C_{BATT} = 2.2\mu$ F,  $T_A = +25^{\circ}$ C, unless otherwise noted.)

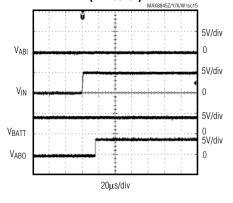




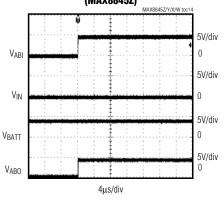




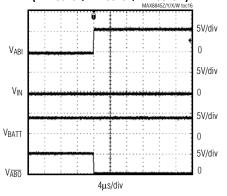




AUTOBOOT ENABLED BY ABI SIGNAL (MAX8845Z)







## **Pin Description**

PIN       MAX8845Y/       MAX8845X/       MAX8845X/       MAX8845W			FUNCTION			
		NAME				
1	1	SETI	Charge-Current Program and Fast-Charge Current Monitor. Output current from SETI is 1016µA per ampere of battery charging current. Set the charging current by connecting a resistor (R <sub>SETI</sub> in Figure 3) from SETI to GND. IFAST-CHARGE = 1400V/R <sub>SETI</sub> . To configure the MAX8845Z/MAX8845Y/MAX8845X/MAX8845W as a USB charger, see Figure 5.			
2	2	DETBAT	Battery Pack ID Resistor Detection Input. If DETBAT is pulled low through a pulldown resistor less than $51k\Omega$ the charger is enabled. If DETBAT is left unconnected, the charger is disabled.			
3	3	ABI	Autobooting External Input. See the Autobooting Assistant section and Table 1 for autobooting conditions. ABI is pulled to GND through an internal $200k\Omega$ resistor.			
4	4	ĒN	Active-Low, Logic-Level Enable Input. Drive $\overline{\text{EN}}$ high to disable charger. Drive $\overline{\text{EN}}$ low or leave unconnected for normal operation. $\overline{\text{EN}}$ has an internal 200k $\Omega$ pulldown resistor.			
5	5	GND	Ground. Connect GND and the exposed pad to a large copper ground plane for maximum power dissipation. Connect GND to the exposed pad directly under the IC.			
6	6	POK	Active-Low, Input Voltage Status Indicator. $\overline{\text{POK}}$ is an open-drain output that asserts low when 2.35V < V <sub>IN</sub> < 7V (7.5V for MAX8845X only) and (V <sub>IN</sub> - V <sub>BATT</sub> ) $\geq$ 40mV. If V <sub>IN</sub> > +7.5V (+8.0V for MAX8845X only) or V <sub>BATT</sub> > V <sub>IN</sub> the IC is shut down and $\overline{\text{POK}}$ becomes high impedance. Connect a pullup resistor to the microprocessor's I/O voltage when interfacing with a microprocessor logic input.			
7	_	ABO	Active-High, Autobooting Logic Output. See the <i>Autobooting Assistant</i> section and Table 1 for autobooting conditions.			
—	7	ABO	Active-Low, Open-Drain Logic Output. See the <i>Autobooting Assistant</i> section and Table 1 for autobooting conditions.			
8	8	BATT	Li+ Battery Connection. Bypass BATT to GND with a 2.2µF ceramic capacitor.			
9	9	MIN	Top-Off Current Threshold Programmable Input. $I_{MIN}$ (mA) falling = 148V/R_{MIN} (k $\Omega) + 22$ (mA).			
10	10	CHG	Active-Low, Charging Indicator. CHG is an open-drain output that is pulled low once charging begins. CHG is high impedance when the battery current drops below MIN, or when the IC is disabled. Connect a pullup resistor to the microprocessor's I/O voltage when interfacing with a microprocessor logic input.			
11	11	IN	Input Supply Voltage. Bypass IN to GND with a $1\mu$ F or larger ceramic capacitor to improve line noise and input transient rejection.			
12	12	SAFEOUT	4.7V (MAX8845Z/MAX8845Y/MAX8845W) or 4.85V (MAX8845X) Regulated LDO Output with Input Overvoltage Protection. Bypass SAFEOUT to GND with a 1µF or larger ceramic capacitor. SAFEOUT can be used to supply low voltage-rated USB systems.			
_		EP	Exposed Pad. Connect the exposed pad to a large ground plane for maximum power dissipation. Connect GND to the exposed pad directly under the IC.			

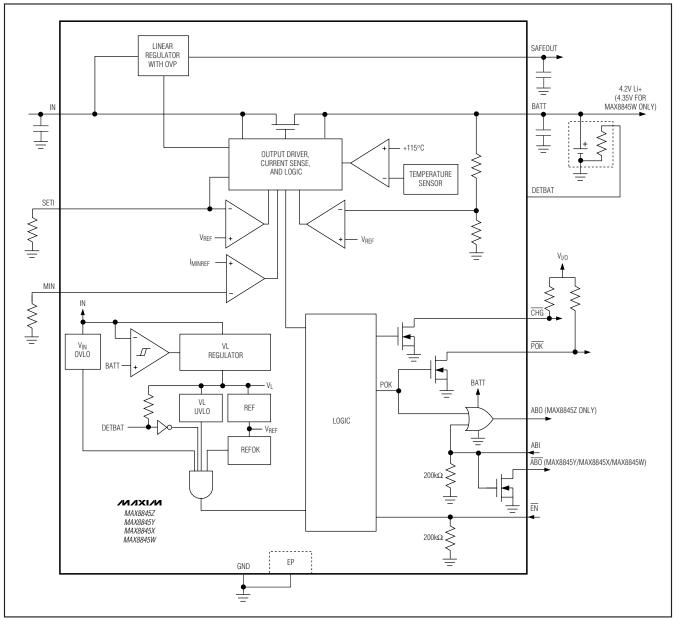


Figure 1. MAX8845Z/MAX8845Y/MAX8845X/MAX8845W Functional Diagram

## **Detailed Description**

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W chargers use voltage, current, and thermal-control loops to charge a single Li+ cell and protect the battery (Figure 1). When a Li+ battery with a cell voltage below 2.5V is inserted, the MAX8845Z/MAX8845Y/MAX8845X/ MAX8845W chargers enter a prequalification stage where it precharges that cell with 10% of the user-pro-

grammed fast-charge current (Figure 2). The CHG indicator is driven low to indicate entry into the prequalification state. When the battery voltage exceeds 2.5V, the charger soft-starts as it enters the fast-charge stage. The fast-charge current level is programmed through a resistor from SETI to GND. As the battery voltage approaches 4.2V, the charging current is reduced. If the battery current drops to less than the



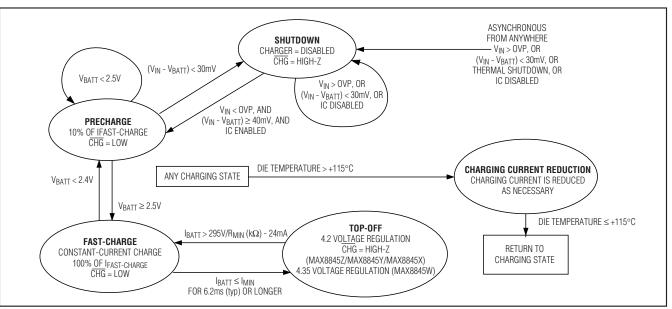


Figure 2. Charge-State Diagram

top-off current threshold set by  $R_{MIN}$ , the charger enters top-off mode and the  $\overline{CHG}$  indicator goes high impedance signaling that the battery is fully charged.

#### **Overvoltage-Protected Output (SAFEOUT)**

SAFEOUT is a linear regulator that provides an output voltage of 4.7V (MAX8845Z/MAX8845Y/MAX8845W) or 4.85V (MAX8845X) and can be used to supply low voltage-rated USB systems. The SAFEOUT linear regulator turns on when  $V_{IN} \ge 4.25V$  regardless of  $\overline{EN}$  and is disabled when  $V_{IN}$  is greater than the overvoltage threshold (7.5V typ) (8.0V typ for MAX8845X only).

#### **Battery-Pack Detection Input (DETBAT)**

DETBAT is a battery-pack ID resistor detector that enables the battery charger if pulled low through a resistor that is less than  $51k\Omega$ . If DETBAT is left unconnected or the pulldown resistor is  $51k\Omega$  or greater the battery charger is disabled. If DETBAT is not used connect DETBAT to GND for normal operation.

#### **POK** Output

The open-drain  $\overrightarrow{POK}$  output asserts low when  $2.35V \le V_{IN} \le 7V$  (7.5V for MAX8845X only) and  $(V_{IN} - V_{BATT}) \ge 40mV$  (typ  $V_{IN}$  rising).  $\overrightarrow{POK}$  is high impedance during shutdown. When interfacing with a microprocessor logic input, a pullup resistor to the microprocessor's I/O voltage may be required.

#### Autobooting Assistant

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W contain autobooting assistant circuits that generate an enable signal for system booting (ABO—MAX8845Z, ABO—MAX8845Y/MAX8845X/MAX8845W). For the MAX8845Z, the booting assistant functions as an internal OR gate (Figure 1). The first input is dependant on the input voltage (V<sub>IN</sub>) and DETBAT while the second input is an external signal applied to ABI. The first input (POK) is driven high once DETBAT is pulled low through a resistor less than 51k $\Omega$ , 2.35V  $\leq$  V<sub>IN</sub>  $\leq$  7V (7.5V for only MAX8845X), and (V<sub>IN</sub> - VBATT)  $\geq$  40mV (typ V<sub>IN</sub> rising).

The second input signal (ABI) is driven by an external source (Table 1). ABI enables an autoboot signal when a battery is connected at BATT and is independent of POK. If POK is pulled low, the booting assistant always drives ABO high regardless of ABI. ABI is pulled to GND through an internal 200k $\Omega$  resistor. If ABI is supplied from an outside exposed pin, a RC filter (Figure 4) is required for ESD protection and noise filtering. If ABI is supplied by a system's internal GPIO, or logic, the RC filter is not required. For the MAX8845Y/MAX8845X/MAX8845W, the output  $\overline{\text{ABO}}$  is only dependent on the state of ABI (Table 1).

#### **CHG Charge Indicator Output**

CHG is an open-drain output that indicates charge status. Table 2 describes the state of CHG during different stages of operation. CHG is suitable for driving a charge indication LED. If the MAX8845Z/MAX8845Y/MAX8845X/



ABI	BATT	РОК	CHARGER STATE	ABO (MAX8845Z)	ABO           (MAX8845Y/           MAX8845X/MAX8845W)
Low	Present	High-Z	Shutdown	Low	High-Z
High	Present	High-Z	Shutdown	High	Low
Low	Not present	Low	CC/CV mode	High	High-Z
Low	Present	Low	Fast-charge/top-off	High	High-Z
High	Present	Low	Fast-charge/top-off	High	Low

## Table 1. Autobooting Output States

**Note:** Present indicates that  $V_{BATT} \ge 2V$  and Not Present indicates that the battery is not connected.

## Table 2. CHG States

ĒN	VIN	VBATT	IBATT	CHG	STATE
High	Х	Х	0	High-Z	Disabled
Low	> 7.5V	Х	0	High-Z S	Shutdown
Low	Х	> V <sub>IN</sub> - 30mV	0		
Low	4.25V (4.4V for MAX8845W only) $\leq$ V <sub>IN</sub> $\leq$ 7.5V	< 2.4V	10% of IFAST-CHARGE*	Low	Precharge
Low	4.25V (4.4V for MAX8845W only) $\leq$ V <sub>IN</sub> $\leq$ 7.5V	≥ 2.5V	100% of IFAST-CHARGE*	Low	Fast-charge
Low	4.25V (4.4V for MAX8845W only) $\leq$ V <sub>IN</sub> $\leq$ 7.5V	4.2V (4.35V for MAX8845W only)	< I <sub>MIN</sub>	High-Z	Top-off

X = Don't care.

\*IFAST-CHARGE is reduced as necessary to prevent the die temperature from exceeding +115°C.

MAX8845W are used in conjunction with a microprocessor, a pullup resistor to the logic I/O voltage allows  $\overline{CHG}$  to indicate charge status to the microprocessor instead of driving an LED.

#### **Thermal Regulation**

The thermal-regulation loop limits the MAX8845Z/ MAX8845Y/MAX8845X/MAX8845W die temperature to +115°C by reducing the charge current as necessary. This feature not only protects the IC from overheating, but also allows a higher charge current without risking damage to the system.

### **Charger Enable Input**

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W contain active-low logic input ( $\overline{EN}$ ) used to enable the chargers. Drive  $\overline{EN}$  low, leave unconnected, or connect to GND to enable the charge-control circuitry. Drive  $\overline{EN}$  high to disable the charger-control circuitry.  $\overline{EN}$  has an internal 200k $\Omega$  pulldown resistor.

**Soft-Start** The soft-start algorithm activates when entering fastcharge mode. When the prequalification state is complete (V<sub>BATT</sub> exceeds +2.5V), the charging current ramps up in 250µs to the full charging current. This reduces the inrush current demand on the input supply.

## **Applications Information**

### Fast Charge-Current Setting

The maximum charging current is programmed by an external resistor connected from SETI to GND ( $R_{SETI}$ ). Use the following equation to determine the fast-charge current (IFAST\_CHARGE):

$$I_{FAST_CHARGE} = \frac{1400V}{R_{SETI}}$$

where IFAST\_CHARGE is in amps and RSETI is in ohms. RSETI must always be  $1.4k\Omega$  or higher due to the continuous charging current limit of 1ARMS.

### **Top-Off Current Threshold Setting**

The top-off current threshold is programmed by an external resistor connected from MIN to GND ( $R_{MIN}$ ). Use the following equation to determine the top-off current ( $I_{MIN}$ ):

 $I_{MIN}$  (falling) = 148V/ $R_{MIN}$  (k $\Omega$ ) + 22mA

 $I_{MIN}$  (rising) = 295V/R<sub>MIN</sub> (k $\Omega$ ) - 24mA

where I\_MIN is in mA and R\_MIN is in k  $\Omega$ . Use R\_MIN  $\leq$  2.2k  $\Omega.$ 

#### **Capacitor Selection**

Connect a ceramic capacitor from BATT to GND for proper stability. Use a  $2.2\mu$ F ceramic capacitor for most applications. Connect a  $1\mu$ F ceramic capacitor from IN to GND. A larger input capacitor can be used for high charging current to reduce input voltage ripple.

Connect a  $1\mu$ F ceramic capacitor from SAFEOUT to GND. A larger bypass capacitor for SAFEOUT can be used for optimum noise immunity. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

#### **Thermal Considerations**

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W are available in thermally enhanced Thin QFN packages with exposed pads. Connect the exposed pad to a large copper ground plane to provide a thermal contact between the device and the circuit board for increased power dissipation. The exposed pad transfers heat away from the device, allowing the IC to charge the battery with maximum current, while minimizing the increase in die temperature.

#### **DC Input Sources**

The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W operate from well-regulated DC sources. The full charging input voltage range is 4.25V (4.4V for MAX8845W only) to 7.5V (8V for MAX8845X only). The device can withstand up to 28V on the input without damage to the IC. If V<sub>IN</sub> is greater than 7.5V (8V for MAX8845X only), the internal overvoltage-protection circuitry disables charging until the input falls below 7.5V (8V for MAX8845X only). An appropriate power supply must provide at least 4.25V at the desired peak charging current and stay below 7V when unloaded.

## **Typical Application Circuits**

#### AC Adapter Application

Figure 3 shows the MAX8845Z as a Li+ battery charger with an AC adapter. The MAX8845Z detects the presence of an input supply and DETBET, resulting in POK pulled low. Once POK is pulled low, the autobooting assistant drives ABO high (MAX8845Z) and enables the power supplies of the system to boot up. The MAX8845Z begins charging the battery when  $\overline{EN}$  is low or unconnected. By monitoring  $\overline{CHG}$ , the system can detect the top-off threshold and terminate the charge through  $\overline{EN}$ . The MAX8845Z/MAX8845Y/MAX8845X/MAX8845W also provide an overvoltage-protected SAFEOUT to the system.

**Factory System Interface Connector Application** Figure 4 shows the MAX8845Z as an autoboot assistor with the factory system interface connector. The MAX8845Z detects the ABI input even though there is no input voltage available and generates an ABO signal to turn on power supplies to boot up the system. The configuration in Figure 4 is used for system development, testing, and calibrations in production or design stage.

#### **USB-Powered Li-Ion Charger**

The universal serial bus (USB) provides a high-speed serial communication port as well as power for the remote device. The MAX8845Z/MAX8845Y/MAX8845X/ MAX8845W can be configured to charge batteries at the highest current possible from the host port. Figure 5 shows the MAX8845Z as a USB battery charger. To make the circuit compatible with either 100mA or 500mA USB ports, the circuit initializes at 100mA charging current. The microprocessor then enumerates the host to determine its current capability. If the host port is capable, the charging current is increased to 450mA to avoid exceeding the 500mA USB specification through GPIO control. The MAX8845Z/MAX8845Y/MAX8845X/ MAX8845W also provide an overvoltage-protected SAFEOUT to the system.

### **Recommended PCB Layout and Routing**

Place all bypass capacitors for IN, BATT, and SAFEOUT as close as possible to the device. Connect the battery to BATT as close as possible to the device to provide accurate battery voltage sensing. Provide a large copper ground plane to allow the exposed pad to sink heat away from the device. Make all high-current traces short and wide to minimize voltage drops. A sample layout is available in the MAX8845Z Evaluation Kit to speed designs.

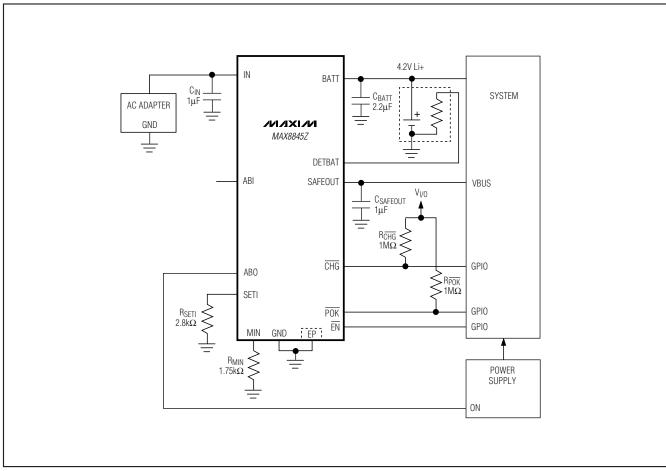


Figure 3. AC Adapter Application

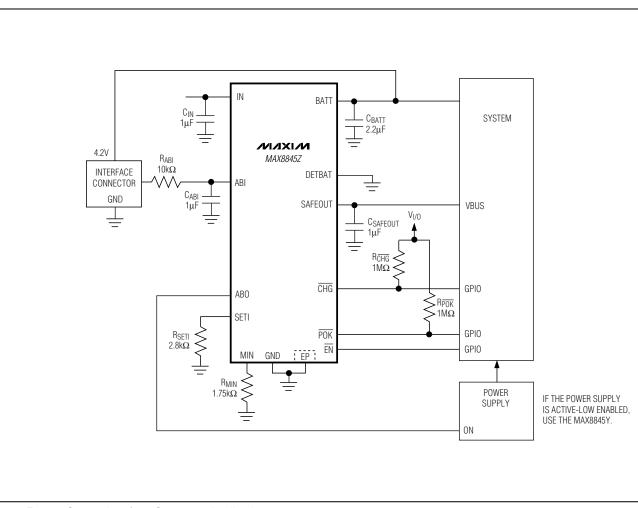


Figure 4. Factory System Interface Connector Application

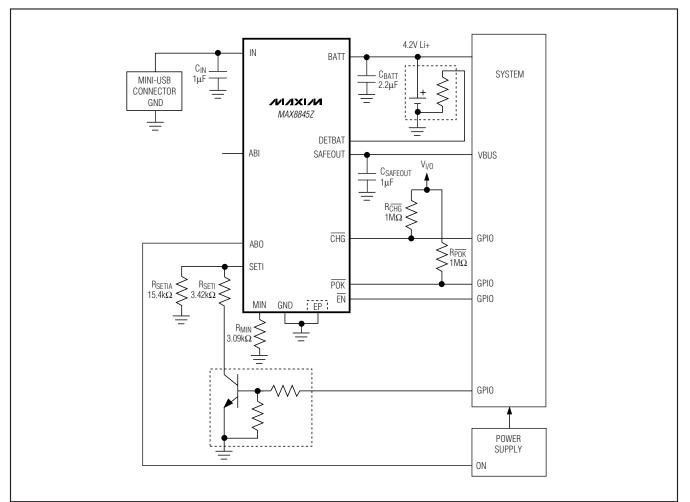


Figure 5. Mini USB Battery Charger

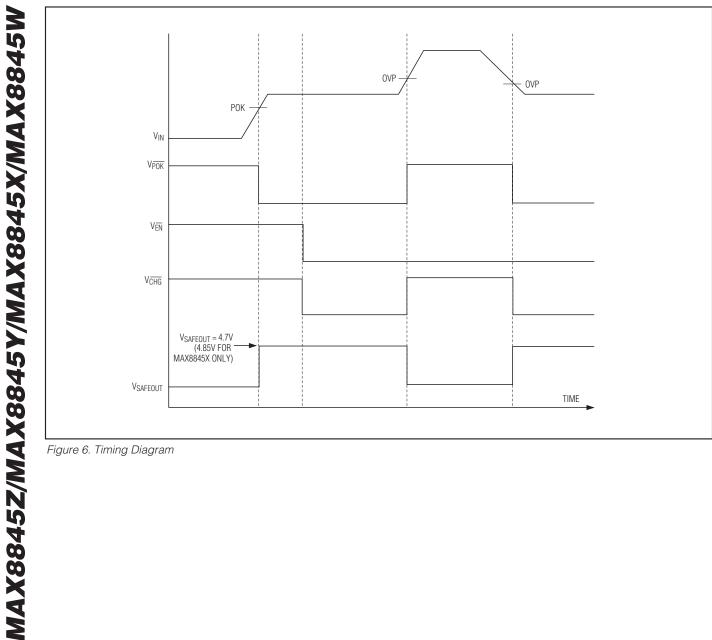
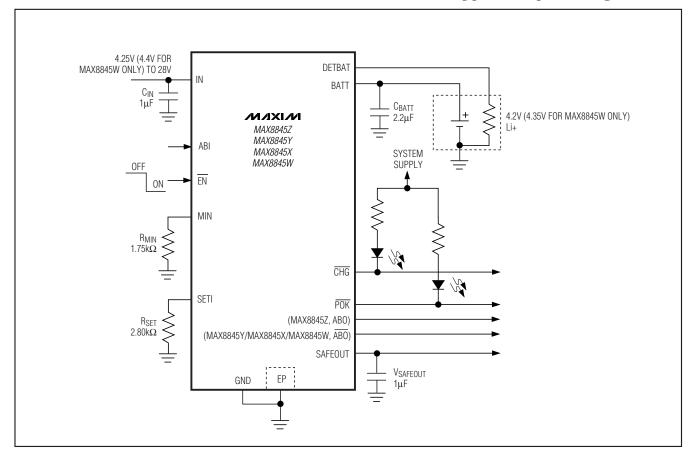
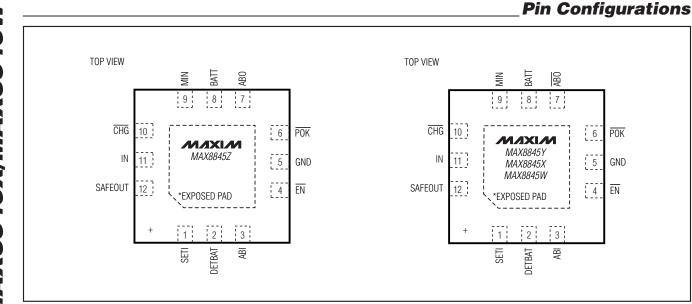


Figure 6. Timing Diagram

## **Typical Operating Circuit**







MAX8845Z/MAX8845Y/MAX8845X/MAX8845W

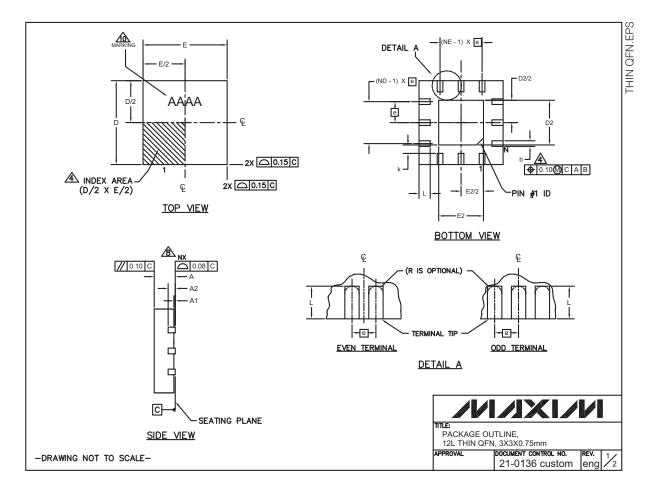
**Chip Information** 

PROCESS: BICMOS

## \_Package Information

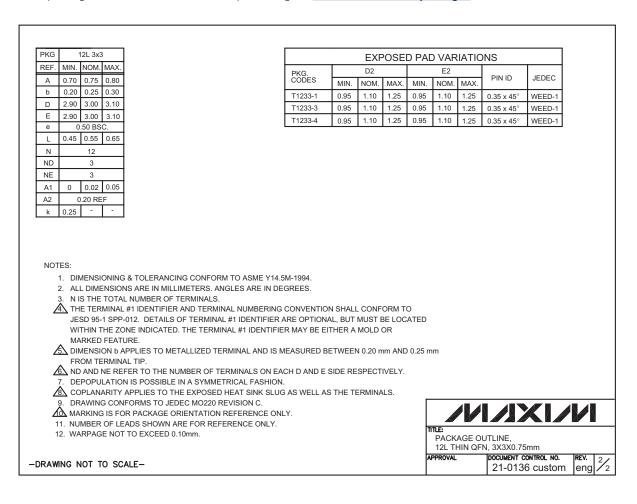
For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.





## **Package Information (continued)**

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## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	3/09	Initial release	—
1	9/09	Corrected the $\overline{POK}$ Output section description and added MAX8845X and MAX8845W to data sheet	1–19

\_\_\_\_ 19

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